

International

Preliminary Data Sheet No. PD60131-L

IR21531D(S)&(PbF)

SELF-OSCILLATING HALF-BRIDGE DRIVER

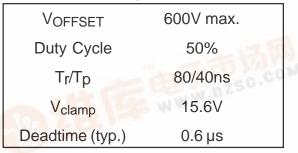
Features

- Integrated 600V half-bridge gate driver
- 15.6V zener clamp on Vcc
- True micropower start up
- Tighter initial deadtime control
- Low temperature coefficient deadtime
- Shutdown feature (1/6th Vcc) on CT pin
- Increased undervoltage lockout Hysteresis (1V)
- Lower power level-shifting circuit
- Constant LO, HO pulse widths at startup
- Lower di/dt gate driver for better noise immunity
- Low side output in phase with RT
- Internal 50nsec (typ.) bootstrap diode (IR21531D)
- Excellent latch immunity on all inputs and outputs
- ESD protection on all leads
- Also available LEAD_FREE

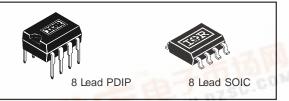
Description

The IR21531(D)(S) are an improved version of the popular IR2155 and IR2151 gate driver ICs, and in-

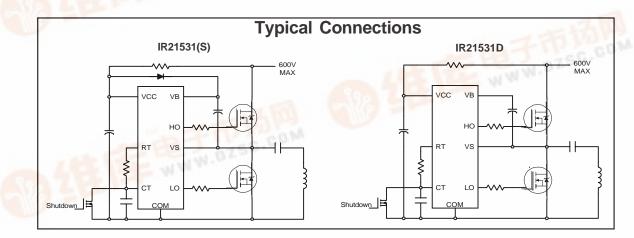
Product Summary



Packages



corporates a high voltage half-bridge gate driver with a front end oscillator similar to the industry standard CMOS 555 timer. The IR21531 provides more functionality and is easier to use than previous ICs. A shutdown feature has been designed into the C_T pin, so that both gate driver outputs can be disabled using a low voltage control signal. In addition, the gate driver output pulse widths are the same once the rising undervoltage lockout threshold on V_{CC} has been reached, resulting in a more stable profile of frequency vs time at startup. Noise immunity has been improved significantly, both by lowering the peak di/dt of the gate drivers, and by increasing the undervoltage lockout hysteresis to 1V. Finally, special attention has been payed to maximizing the latch immunity of the device, and providing comprehensive ESD protection on all pins.





International

Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units		
VB	High side floating supply voltage	-0.3	625			
VS	High side floating supply offset voltage		V _B - 25	V _B + 0.3	-	
V _{HO}	High side floating output voltage		V _S - 0.3	V _B + 0.3		
V _{LO}	Low side output voltage		-0.3	V _{CC} +0.3	V	
V _{RT}	R _T pin voltage		-0.3	V _{CC} +0.3	-	
V _{CT}	C _T pin voltage	-0.3	V _{CC} +0.3	-		
lcc	Supply current (note 1)	_	25	mA		
I _{RT}	R _T pin current		-5	5		
dV _s /dt	Allowable offset voltage slew rate		-50	50	V/ns	
PD	Maximum power dissipation @ $T_A \le +25^{\circ}C$	(8 Lead DIP)	_	1.0	w	
	(8 Lead SOIC)		—	0.625	vv	
RthJA	Thermal resistance, junction to ambient	(8 Lead DIP)	_	125	8 0 AA/	
	(8 Lead SOIC)		_	200	°C/W	
TJ	Junction temperature	-55	150			
Τ _S	Storage temperature	-55	150	°C		
TL	Lead temperature (soldering, 10 seconds)	_	300			

Recommended Operating Conditions

For proper operation the device should be used within the recommended conditions.

Symbol	Definition	Min.	Max.	Units
V _{BS}	High side floating supply voltage	V _{CC} - 0.7	VCLAMP	
Vs	Steady state high side floating supply offset voltage	-3.0 (note 2)	600	V
V _{CC}	Supply voltage	10	VCLAMP	
Icc	Supply current	(note 3)	5	mA
TJ	Junction temperature	-40	125	°C

Note 1: This IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.6V. Please note that this supply pin should not be driven by a DC, low impedance power source greater than the V_{CLAMP} specified in the Electrical Characteristics section.

Note 2: Care should be taken to avoid output switching conditions where the V_S node flies inductively below ground by more than 5V.

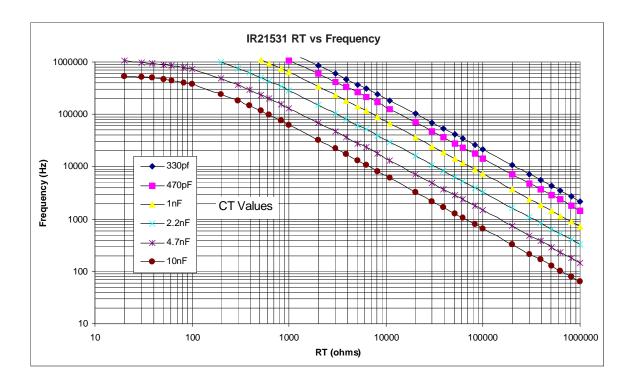
Note 3: Enough current should be supplied to the V_{CC} pin of the IC to keep the internal 15.6V zener diode clamping the voltage at this pin.

International **ISR** Rectifier

IR21531D(S)&(PbF)

Recommended Component Values

Symbol	Component	Min.	Max.	Units
R _T	Timing resistor value	10	_	kΩ
CT	C _T pin capacitor value	330	_	pF



International

Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS}) = 12V, C_L = 1000 pF, C_T = 1 nF and T_A = 25°C unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
V _{CCUV+}	Rising V _{CC} undervoltage lockout threshold	8.1	9.0	9.9		
VCCUV-	Falling V _{CC} undervoltage lockout threshold	7.2	8.0	8.8	V	
VCCUVH	V _{CC} undervoltage lockout Hysteresis	0.5	1.0	1.5	1	
IQCCUV	Micropower startup V _{CC} supply current	_	75	150		V _{CC} ≤V _{CCUV} -
locc	Quiescent V _{CC} supply current	_	500	950	μΑ	
VCLAMP	V _{CC} zener clamp voltage	14.4	15.6	16.8	V	$I_{CC} = 5mA$
Floating	g Supply Characteristics					
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
IQBSUV	Micropower startup V _{BS} supply current	_	0	10		V _{CC} ≤V _{CCUV} -
IQBS	Quiescent VBS supply current	_	30	50	μΑ	
VBSMIN	Minimum required V _{BS} voltage for proper	—	4.0	5.0	V	V _{CC} =V _{CCUV+} + 0.1V
	functionality from R _T to HO					
I _{LK}	Offset supply leakage current	—	_	50	μA	$V_B = V_S = 600V$
VF	Bootstrap diode forward voltage (IR21531D)	0.5	_	1.0	V	IF = 250mA
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
Symbol fosc	Definition Oscillator frequency	Min. 19.4	Typ. 20	Max. 20.6		Test Conditions R _T = 36.9kΩ
fosc	Oscillator frequency		20 100	20.6 106	- kHz	R _T = 36.9kΩ RT = 7.43kΩ
fosc	Oscillator frequency R⊤ pin duty cycle	19.4	20	20.6		R _T = 36.9kΩ
fosc	Oscillator frequency RT pin duty cycle CT pin current	19.4 94	20 100	20.6 106	- kHz	$R_T = 36.9kΩ$ $R_T = 7.43kΩ$ fo < 100kHz
fosc d Ict Ictuv	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current	19.4 94 48	20 100 50	20.6 106 52	kHz %	R _T = 36.9kΩ RT = 7.43kΩ
fosc d I _{CT} I _{CTUV} V _{CT+}	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold	19.4 94 48 —	20 100 50 0.001 0.70 8.0	20.6 106 52 1.0 1.2 —	kHz % uA mA	$R_T = 36.9kΩ$ $R_T = 7.43kΩ$ fo < 100kHz
fosc d Ict Ictuv	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold	19.4 94 48 —	20 100 50 0.001 0.70	20.6 106 52 1.0	kHz % uA	$R_T = 36.9 kΩ$ $R_T = 7.43 kΩ$ fo < 100kHz
fosc d I _{CT} I _{CTUV} V _{CT+}	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold CT voltage shutdown threshold	19.4 94 48 —	20 100 50 0.001 0.70 8.0 4.0 2.1	20.6 106 52 1.0 1.2 — 2.4	kHz % uA mA	$R_T = 36.9kΩ$ $R_T = 7.43kΩ$ fo < 100kHz $V_{CC} = 7V$
fosc d ICT ICTUV VCT+ VCT-	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold	19.4 94 48 0.30 	20 100 50 0.001 0.70 8.0 4.0 2.1 10	20.6 106 52 1.0 1.2 2.4 50	kHz % uA mA	$R_{T} = 36.9kΩ$ $R_{T} = 7.43kΩ$ fo < 100kHz $V_{CC} = 7V$ $I_{RT} = 100μA$
d lcT lCTUV VCT+ VCT- VCTSD VRT+	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold CT voltage shutdown threshold High-level RT output voltage, VCC - VRT	19.4 94 48 0.30 1.8	20 100 50 0.001 0.70 8.0 4.0 2.1 10 100	20.6 106 52 1.0 1.2 2.4 50 300	kHz % uA mA	$R_{T} = 36.9kΩ$ $R_{T} = 7.43kΩ$ fo < 100kHz $V_{CC} = 7V$ $I_{RT} = 100μA$ $I_{RT} = 1mA$
fosc d ICT ICTUV VCT+ VCT- VCTSD	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold CT voltage shutdown threshold	19.4 94 48 0.30 1.8	20 100 50 0.001 0.70 8.0 4.0 2.1 10 100 10	20.6 106 52 1.0 1.2 2.4 50 300 50	kHz % uA mA	$R_{T} = 36.9kΩ$ $R_{T} = 7.43kΩ$ fo < 100kHz $V_{CC} = 7V$ $I_{RT} = 100μA$ $I_{RT} = 1mA$ $I_{RT} = 100μA$
fosc d ICT ICTUV VCT+ VCT- VCTSD VRT+ VRT-	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold CT voltage shutdown threshold High-level RT output voltage Low-level RT output voltage	19.4 94 48 0.30 1.8	20 100 50 0.001 0.70 8.0 4.0 2.1 10 100 10 100	20.6 106 52 1.0 1.2 2.4 50 300 50 300	kHz % uA mA	$R_{T} = 36.9kΩ$ $R_{T} = 7.43kΩ$ fo < 100kHz $V_{CC} = 7V$ $I_{RT} = 100μA$ $I_{RT} = 1mA$ $I_{RT} = 100μA$ $I_{RT} = 100μA$ $I_{RT} = 1mA$
fosc d ICT ICTUV VCT+ VCT- VCTSD VRT+ VRT- VRT-	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold CT voltage shutdown threshold High-level RT output voltage UV-mode RT output voltage	19.4 94 48 0.30 1.8	20 100 50 0.001 0.70 8.0 4.0 2.1 10 100 10 100 0	20.6 106 52 1.0 1.2 2.4 50 300 50 300 100	kHz % uA mA V	$R_{T} = 36.9k\Omega$ $R_{T} = 7.43k\Omega$ fo < 100kHz $V_{CC} = 7V$ $I_{RT} = 100\mu A$ $I_{RT} = 1mA$ $I_{RT} = 100\mu A$
fosc d ICT ICTUV VCT+ VCT- VCTSD VRT+ VRT-	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold CT voltage shutdown threshold High-level RT output voltage Low-level RT output voltage	19.4 94 48 0.30 1.8	20 100 50 0.001 0.70 8.0 4.0 2.1 10 100 10 100	20.6 106 52 1.0 1.2 2.4 50 300 50 300	kHz % uA mA V	$R_{T} = 36.9kΩ$ $R_{T} = 7.43kΩ$ fo < 100kHz $V_{CC} = 7V$ $I_{RT} = 100μA$ $I_{RT} = 1mA$ $I_{RT} = 100μA$ $I_{RT} = 1mA$ $V_{CC} \le V_{CCUV}$ $I_{RT} = 100μA$,
fosc d ICT ICTUV VCT+ VCT- VCTSD VRT+ VRT- VRT-	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold CT voltage shutdown threshold High-level RT output voltage UV-mode RT output voltage	19.4 94 48 0.30 1.8	20 100 50 0.001 0.70 8.0 4.0 2.1 10 100 10 100 0 10	20.6 106 52 1.0 1.2 2.4 50 300 50 300 100 50	kHz % uA mA V	$R_{T} = 36.9kΩ$ $R_{T} = 7.43kΩ$ fo < 100kHz $V_{CC} = 7V$ $I_{RT} = 100μA$ $I_{RT} = 1mA$ $I_{RT} = 1mA$ $I_{RT} = 1mA$ $V_{CC} \le V_{CCUV}$ $I_{RT} = 100μA$, $V_{CT} = 0V$
fosc d ICT ICTUV VCT+ VCT- VCTSD VRT+ VRT- VRT-	Oscillator frequency RT pin duty cycle CT pin current UV-mode CT pin pulldown current Upper CT ramp voltage threshold Lower CT ramp voltage threshold CT voltage shutdown threshold High-level RT output voltage UV-mode RT output voltage	19.4 94 48 0.30 1.8	20 100 50 0.001 0.70 8.0 4.0 2.1 10 100 10 100 0	20.6 106 52 1.0 1.2 2.4 50 300 50 300 100	kHz % uA mA V	$R_{T} = 36.9 k\Omega$ $R_{T} = 7.43 k\Omega$ fo < 100 kHz $V_{CC} = 7V$ $I_{RT} = 100 \mu A$ $I_{RT} = 1 m A$ $I_{RT} = 100 \mu A$ $I_{RT} = 100 \mu A$ $I_{RT} = 1 m A$ $V_{CC} \le V_{CCUV}$ $I_{RT} = 100 \mu A,$

International **IGR** Rectifier

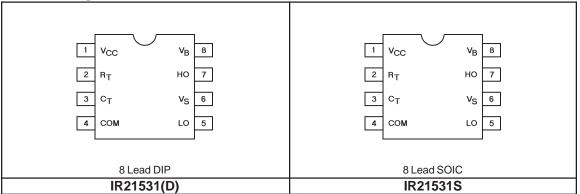
Electrical Characteristics (cont.)

Gate Driver Output Characteristics						
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
VOH	High level output voltage, VBIAS -VO	—	0	100		I _O = OA
VOL	Low-level output voltage, VO	—	0	100	mV	I _O = OA
VOL_UV	UV-mode output voltage, VO	—	0	100		I _O = OA
						V _{CC} ≤V _{CCUV} -
tr	Output rise time	—	80	150		
tf	Output fall time	—	45	100	nsec	
t _{sd}	Shutdown propogation delay	—	660	—	1	
td	Output deadtime (HO or LO)	0.35	0.60	0.85	μsec	

Lead Definitions

Symbol	Description
V _{CC}	Logic and internal gate drive supply voltage
RT	Oscillator timing resistor input
CT	Oscillator timing capacitor input
COM	IC power and signal ground
LO	Low side gate driver output
Vs	High voltage floating supply return
НО	High side gate driver output
VB	High side gate driver floating supply

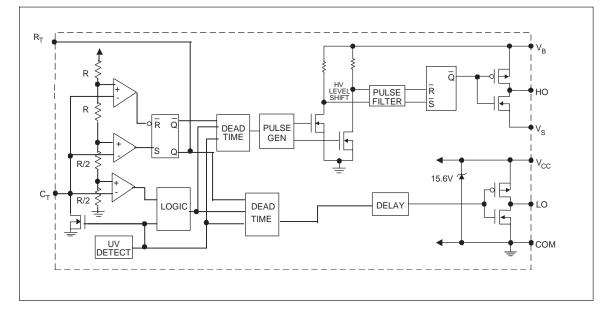
Lead Assignments



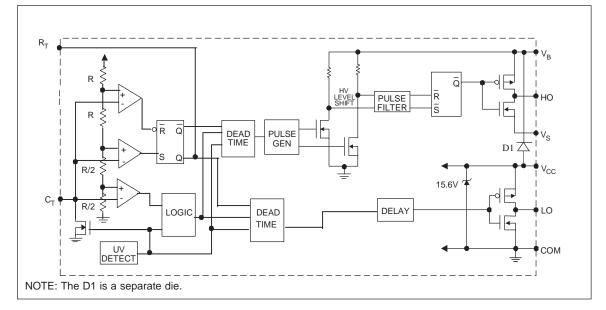
NOTE: The IR21531D is offered in 8 lead DIP only.

International

Functional Block Diagram for IR21531(S)

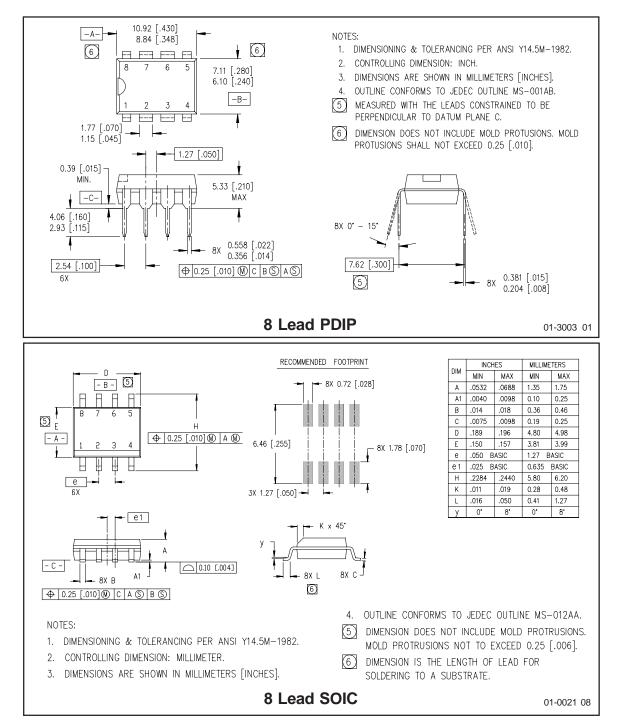


Functional Block Diagram for IR21531D



International **ICOR** Rectifier

IR21531D(S)&(PbF)



International **tor** Rectifier

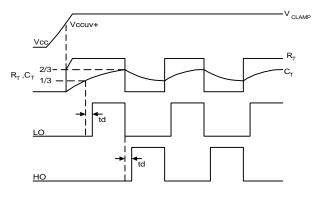


Figure 1. Input/Output Timing Diagram

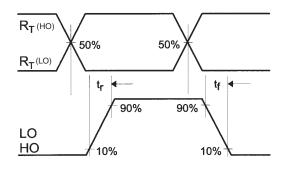


Figure 2. Switching Time Waveform Definitions

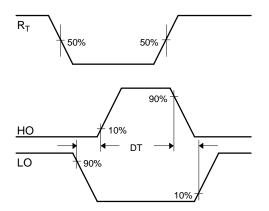
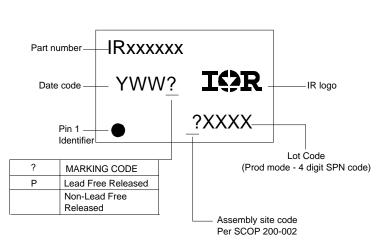


Figure 3. Deadtime Waveform Definitions

www.irf.com

International **ICR** Rectifier



LEADFREE PART MARKING INFORMATION

ORDER INFORMATION

Basic Part (Non-Lead Free)

8-Lead PDIP IR21531D order IR21531D 8-Lead SOIC IR21531S order IR21531S

Leadfree Part

8-Lead PDIP IR21531D order IR21531DPbF 8-Lead SOIC IR21531S order IR21531SPbF

International IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245 Tel: (310) 252-7105 This product has been qualified per industrial level Data and specifications subject to change without notice. 4/2/2004